



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
60V	5.0Ω @ V _{GS} = 10V	210mA
607	7.5Ω @ V _{GS} = 5V	170mA

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Motor Control
- Power Management Functions

Features

- Low On-Resistance: R_{DS(ON)}
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

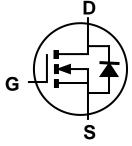
Mechanical Data

- Case: SOT523
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Alloy 42 Leadframe.
 Solderable per MIL-STD-202, Method 208 63
- Terminal Connections: See Diagram
- Weight: 0.002 grams (Approximate)

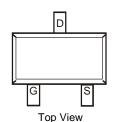




Top View



Equivalent Circuit



Pin Out Configuration

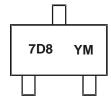
Ordering Information (Note 4)

Part Number	Case	Packaging
DMN67D8LT-7	SOT523	3000/Tape & Reel
DMN67D8LT-13	SOT523	10000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



7D8 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Key

Date Code Ney												
Year	2015		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	С		Н		J	K	Ĺ	М	N	0	Р	R
										_		
		l.					_			_		
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	60 V			
Gate-Source Voltage			V_{GSS}	±20	V
Continuous Drain Current (Note 6) V _{GS} = 10V	ΙD	210 170	mA		
Maximum Continuous Body Diode Forward Currer	Is	210	mA		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	%)		I _{DM}	0.8	Α

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		P_{D}	260	mW
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	497	°C/W
Total Power Dissipation (Note 6)		PD	350	mW
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	366	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 7)								
Drain-Source Breakdown Voltage	BV _{DSS}	60			V	$V_{GS} = 0V, I_{D} = 10\mu A$		
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1.0	μΑ	$V_{DS} = 60V, V_{GS} = 0V$		
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 7)								
Gate Threshold Voltage	Vgs(TH)	1.0	1	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$		
Static Drain-Source On-Resistance	D-s/s/		3.2	7.5	Ω	$V_{GS} = 5.0V, I_{D} = 0.05A$		
Static Dialif-Source Off-Resistance	R _{DS(ON)}	_	1.5	5.0	2.2	$V_{GS} = 10V, I_D = 0.5A$		
Forward Transconductance	g FS	80	1	1	mS	$V_{DS} = 10V, I_{D} = 0.2A$		
Diode Forward Voltage	V_{SD}		0.78	1.5	V	$V_{GS} = 0V, I_{S} = 115mA$		
DYNAMIC CHARACTERISTICS (Note 8)								
Input Capacitance	Ciss	_	22	_	pF	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		
Output Capacitance	Coss		4.1		pF	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz		
Reverse Transfer Capacitance	Crss	_	2.5	_	pF	1 = 1.000112		
Gate Resistance	R_g		120		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$		
Total Gate Charge (VGS = 4.5V)	Qg	1	361	1				
Total Gate Charge (V _{GS} = 10V)	Q_g		821		200	\/ 40\/ I- 050mA		
Gate-Source Charge	Q_{gs}	_	162	_	pC	$V_{DS} = 10V, I_{D} = 250mA$		
Gate-Drain Charge	Q_{gd}	_	116	_				
Turn-On Delay Time	t _{D(ON)}		2.8			V 00V I 0.04		
Turn-On Rise Time	t _R		3.0		ns	V _{DD} = 30V, I _D = 0.2A,		
Turn-Off Delay Time	tD(OFF)		7.6		115	$R_L = 150\Omega$, $V_{GEN} = 10V$, $R_{GEN} = 25\Omega$		
Turn-Off Fall Time	tF	1	5.6	1		2022		

Notes: 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.

- 6. Device mounted on 1" \times 1" FR-4 PCB with high coverage 2oz. Copper, single sided.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.





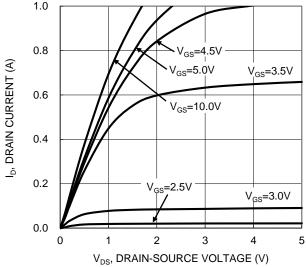


Figure 1. Typical Output Characteristic

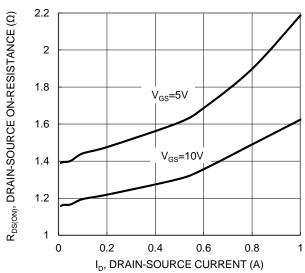


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

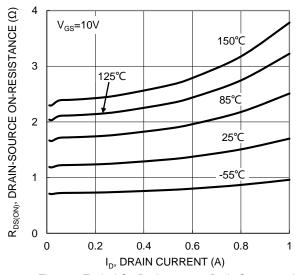


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

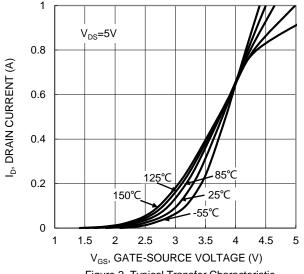
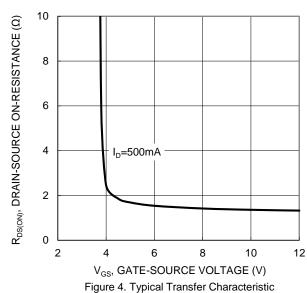


Figure 2. Typical Transfer Characteristic



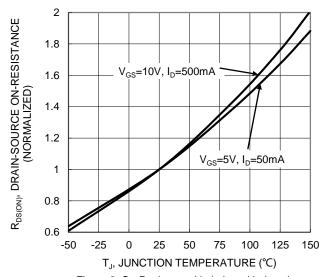
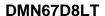


Figure 6. On-Resistance Variation with Junction Temperature





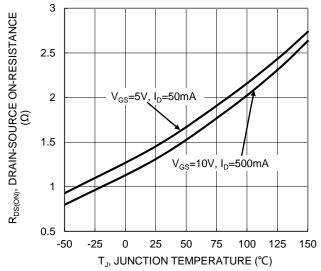


Figure 7. On-Resistance Variation with Junction Temperature

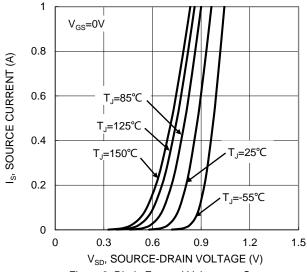


Figure 9. Diode Forward Voltage vs. Current

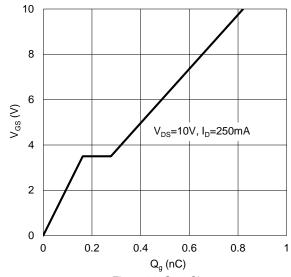


Figure 11. Gate Charge

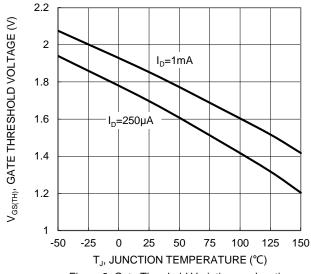


Figure 8. Gate Threshold Variation vs. Junction Temperature

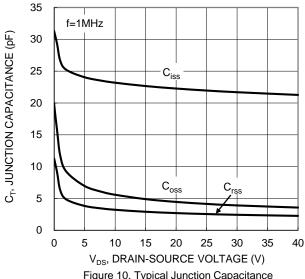


Figure 10. Typical Junction Capacitance

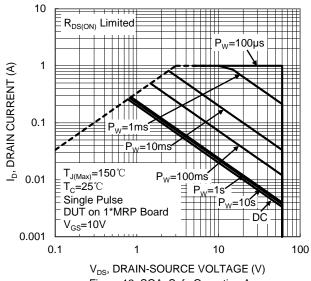


Figure 12. SOA, Safe Operation Area



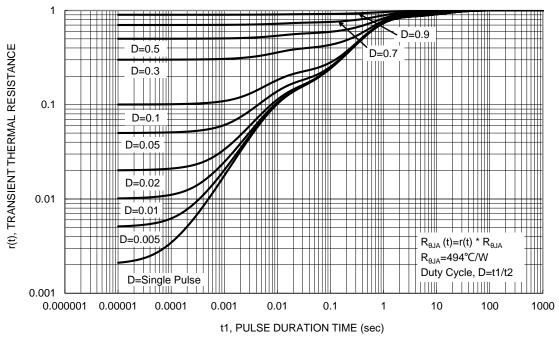


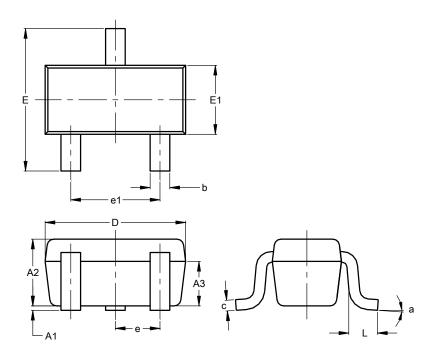
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT523

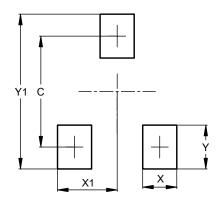


SOT523						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.60	0.80	0.75			
A3	0.45	0.65	0.50			
b	0.15	0.30	0.22			
C	0.10	0.20	0.12			
D	1.50	1.70	1.60			
Е	1.45	1.75	1.60			
E1	0.75	0.85	0.80			
e		0.50 BS	С			
e1	0.90	1.10	1.00			
L	0.20	0.40	0.33			
а	0°		8°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT523



Dimensions	Value (in mm)
С	1.29
Х	0.40
X1	0.70
Y	0.51
Y1	1.80



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